## Physics and detectors at CLIC

#### Philipp Roloff (CERN) on behalf of the CLIC physics and detector study





## Outline



- The CLIC accelerator
- Physics at CLIC
- Detector requirements
- The CLIC\_ILD and CLIC\_SiD detectors
- Background suppression & event reconstruction
- Physics benchmark studies
- CLIC energy staging
- Beyond the CDR
- Summary and conclusions





# The CLIC accelerator

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## CLIC and ILC



 $e^+e^-$  collisions at high energies  $\rightarrow$  linear accelerators



#### International Linear Collider (ILC):

- Based on superconducting RF cavities (like XFEL)
- Gradient: 32 MV/m
- Energy: 500 GeV, upgradable to 1 TeV
- Detector studies focussed mostly on up to 500 GeV, work for 1 TeV ongoing

#### Compact Linear Collider (CLIC):

- Based on 2-beam acceleration scheme
- Operated at room temperature
- Gradient: 100 MV/m
- Energy: <u>3 TeV</u>, staged construction in steps starting from few hundred GeV possible
- Detector study focusses on 3 TeV, investigation of lower energies in progress

Luminosities: few 10<sup>34</sup> cm<sup>-2</sup>s<sup>-1</sup>



## 2-beam acceleration scheme







## CLIC accelerator complex



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- Conceptual Design Report (CDR) stage just finished
- Moving towards a technical design phase

#### Three volumes of the CLIC CDR:

- 1. Accelerator:
  - No show-stoppers identified
  - Accelerating gradient in reach
  - Officially presented to CERN SPC, final text editing ongoing
- 2. Physics and detectors:
  - Published: http://arxiv.org/abs/1202.5940
- 3. Strategic CDR volume:
  - Energy staging, cost, ...
  - In progress, ready summer 2012

#### Signatories list of the CDR:

http://indico.cern.ch/conferenceDisplay.py?confld=136364





## Selected CLIC parameters







Significant energy loss at the interaction point due to **Beamstrahlung** 





## Beam related backgrounds







Coherent  $e^+e^-$  pairs: 7 · 10<sup>8</sup> per BX, very forward Incoherent  $e^+e^-$  pairs: 3 · 10<sup>5</sup> per BX, rather forward  $\rightarrow$  Detector design issue (high occupancies)

#### $\gamma\gamma \rightarrow hadrons$

• "Only" 3.2 per BX

- Main background in calorimeters and trackers
- $\rightarrow$  Impact on physics







## Physics at CLIC



## **CLIC physics potential**



#### Advantage of e<sup>+</sup>e<sup>-</sup> collisions:

- Defined initial state
- Precision measurements possible due to clean conditions
- Well suited for weakly interacting states (e.g. sleptons, gauginos)
- Polarised (electron) beam

### → Complementary / enhanced discovery reach compared to the LHC





## **SM Higgs production**







## Example Higgs observables



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Ημμ



## Resolving new physics models

Precision measurements at CLIC allow to discriminate between new physics models, e.g. following first observations at the LHC **Example:** SUSY breaking models with nearly degenerate mass spectra







#### Indicative discovery reach:

New particle	collider: $\mathscr{L}$ :	LHC14 100 fb <sup>-1</sup>	SLHC 1 ab <sup>-1</sup>	$LC800 \\ 500 \text{ fb}^{-1}$	CLIC3 1 $ab^{-1}$
squarks [TeV]		2.5	3	0.4	1.5
sleptons [TeV]		0.3	-	0.4	1.5
Z' (SM couplings) [TeV]		5	7	8	20
2 extra dims $M_D$ [TeV]		9	12	5-8.5	20-30
TGC $(95\%)$ ( $\lambda_{\gamma}$ coupling)		0.001	0.0006	0.0004	0.0001
$\mu$ contact scale [TeV]		15	-	20	60
Higgs compos. scale [TeV]		5-7	9-12	45	60





# Detector requirements

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## Physics aims $\rightarrow$ detector needs

#### Momentum resolution

(e.g. Higgs recoil mass,  $h \rightarrow \mu^+ \mu^-$ , leptons from BSM processes)

$$\frac{\sigma(p_T)}{p_T^2} \sim 2 \times 10^{-5} \, GeV^{-1}$$

• Jet energy resolution (e.g. W/Z/h separation)

$$\frac{\sigma(E)}{E} \sim 3.5 - 5\%$$
 for  $E = 1000 - 50 \, GeV$ 

• Impact parameter resolution (b/c tagging, e.g. Higgs couplings)

$$\sigma(d_0) = \sqrt{a^2 + b^2 \cdot GeV^2 / (p^2 \sin^3 \theta)}, a \approx 5 \, \mu m, b \approx 15 \, \mu m$$

Lepton identification, very forward electron tagging



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Lepton identification, very forward electron tagging

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### **General readout considerations**

## 3.2 $\gamma\gamma \rightarrow hadr.$ interactions per bunch crossing:

- 19 TeV in the calorimeters per 156 ns bunch train
- 5000 tracks with a total momentum of 7.3 TeV



#### Triggerless readout of full bunch train:

- Time-stamping in tracking detectors and calorimeters
- Multi-hit storage / readout
- Filtering algorithms at reconstruction level ( $\rightarrow$  later)





# The CLIC\_ILD and CLIC\_SiD detectors



### **Detector overview**





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## **CLIC detector concepts**



#### Based on validated ILC designs, adapted and optimised to the CLIC conditions:

- Denser HCAL in the barrel (Tungsten, 7.5  $\lambda$ )
- Redesign of the vertex and forward detectors (backgrounds)
- Precise timing capabilities of most subdetectors







## Vertex detectors



## Vertex detector requirements

#### **Requirements:**

- 20 x 20 µm<sup>2</sup> pixel size
- Material: 0.2% X<sub>o</sub> per layer:
  - Very thin materials / sensors
  - Low-power design, power pulsing, low-mass cooling
- Time stamping precision: ≈10 ns (to reject backgrounds)
- Radiation level: ≈10<sup>10</sup> n<sub>eq</sub> /cm<sup>2</sup> /yr (10<sup>-4</sup> of LHC)





## Vertex detector backgrounds

#### Incoherent pair background determines:

Locations of vertex detector & forward tracking disks, design of beam pipe





## Vertex detector cooling



#### Vertex detector: $P \approx 500 \text{ W} \rightarrow \text{need low mass cooling solutions}$

#### Forced (dry) air flow:

- Baseline for barrel region
- No extra material
- FEM studies show encouraging first results

#### Options in forward disks:

- Evaporative CO<sub>2</sub> cooling
- (high pressure  $\rightarrow$  thick tubes)
- Water cooling (sub-atmospheric pressure)

#### Micro-channel cooling:

- Ongoing R&D (e.g. NA62 upgrade)
- Integrate cooling channels in Silicon
- May be suitable for regions with insufficient air flow







## **Pixel sensor options I**



#### 1.) Hybrid technologies:

- Thinned high-resistivity fully depleted sensors
- Fast, low-power highly integrated readout chip
- Low mass interconnects
- **Pros:** Factorisation of sensor + readout R&D
  - $\rightarrow$  Readout chips profit fully from
  - advancing industry standards
- **Cons:** Interconnect difficult / expensive  $\rightarrow$  needs R&D
  - Harder to reduce material
- Thinned high-resistivity fully depleted sensors:
  - 50 µm active thickness
  - ALICE pixel upgrade  $\rightarrow$  meets CLIC goals
- Fast low-power readout chips:
  - Timepix3 (≈2013) in 130 nm IBM CMOS:
    - 55 x 55  $\mu$ m<sup>2</sup> pixels
    - 1.5 ns time resolution  $\rightarrow$  exceeds CLIC goals
    - P  $\approx$  10  $\mu$ W / pixel
  - CLICPix (≈2015) in 65 nm, 20 x 20 µm<sup>2</sup> pixels
  - CLICPix demonstrator prototypes (≈2013): 64x64 pixel array





## **Pixel sensor options II**



#### 2.) Integrated technologies:

- Sensor and readout combined in one chip
- Charge collection in epitaxial layer
- **Pros:** Allows for very low material solutions
  - Synergy with R&D for ILC detectors
- **Cons:** Harder to achieve good time resolution and sufficient S/N
- Several active R&D programs (targeted to ILC requirements)
- Attempts to reach faster signal collection and ns time-stamping capability (compatible with CLIC requirements):
  - MIMOSA CMOS with high-resistivity epitaxial layers
  - Chronopixel CMOS
  - INMAPS
  - High voltage CMOS

#### 3.) New technologies:

- Silicon-On-Insulator (SOI)
  - Full 3D-integrated pixel sensors





## Tracking

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Tracking in CLIC\_ILD







## **Occupancies in the TPC**



The readout time of the TPC is much longer than a CLIC bunch train  $\rightarrow$  The TPC integrates the background of a full train at CLIC



Plots are for Gas Electron Multiplier (GEM) + Pad readout, voxels of 25 ns

 $\rightarrow$  A TPC at CLIC may need a larger inner radius or very small pads Similar study with micromegas + pixel readout is starting

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## Tracking in CLIC\_SiD



Two readout (KPiX) chips bump

bonded to the sensor

#### All silicon tracker in 5T field:

- Vertex detector and tracker viewed as one system
- Combined seeding and tracking







## Calorimetry





Detector design driven by jet energy resolution and background rejection  $\rightarrow$  Fine-grained calorimetry + particle flow analysis (PFA)

#### What is **PFA**?

Typical jet composition:

- 60% charged particles
- 30% photons
- 10% neutral hadrons

## Always use the best available measurement:

- charged particles
- $\rightarrow$  tracking detectors:  $\bigcirc$
- photons  $\rightarrow$  ECAL:  $\bigcirc$
- neutrals  $\rightarrow$  HCAL:  $\stackrel{\bullet}{\sim}$

#### Hardware and software!





## Calorimetry: technology



#### ECAL:

- Silicon pads or scintillator
- Tungsten absorber
- Cell sizes: 25 mm<sup>2</sup> (CLIC\_ILD) 13 mm<sup>2</sup> (CLIC\_SiD)
- 30 layers in depth
- 23  $X_0^{\circ}$  and 1  $\lambda$

#### HCAL:

- Several options for sensors
- Tungsten (barrel), steel (forward)
- Cell sizes: 9 cm<sup>2</sup> (analog) 1 cm<sup>2</sup> (digital)
- 60 75 layers in depth

• 7.5 λ



 $|\cos(\theta)|$ 



Time development in hadronic showers





- In steel 90% of the energy is recorded within 6 ns (corrected for time-of-flight)
- In tungsten only 82% of the energy is deposited within 25 ns:
- (much larger component of the energy in nuclear fragments)
- $\rightarrow$  Energy resolution degrades if not the majority of calorimeter hits is read

 $\rightarrow$  Need to integrate over  $\approx \! 100$  ns in the reconstruction, keeping the background level low



## Test beam measurements using tungsten absorbers



**Main purpose:** Validation of Geant4 simulation for hadronic showers in tungsten





CERN-PS & SPS, mixed beams 1-300 GeV

2010 & 2011: Analog readout:

- Scintillator tiles 3x3 cm<sup>2</sup>
- Read out by SiPM

**2012 (ongoing):** Digital (1-bit) readout:

- RPCs as active medium
- Fine segmentation with 1x1 cm<sup>2</sup> pads





## Background suppression and event reconstruction





• All hits and tracks in this window are passed to the reconstruction  $\rightarrow$  Physics objects with precise p<sub>+</sub> and cluster time information

#### 2.) Apply cluster-based timing cuts

- Cuts depend on particle-type,  $p_{\tau}$  and detector region
- $\rightarrow$  Protects physics objects at high p<sub>1</sub>





Used in the reconstruction software for CDR simulations:

Subdetector	Reconstruction window	hit resolution	
ECAL	10 ns	1 ns	
HCAL Endcaps	10 ns	1 ns	
HCAL Barrel	100 ns	🗾 1 ns	
Silicon Detectors	10 ns	$10/\sqrt{12}$ ns	
TPC	entire bunch train	n/a	
	<ul> <li>CLIC hardware requirements</li> <li>Achievable in the calorimeters with a</li> </ul>		

sampling every ≈ 25 ns





#### $e^+e^- \rightarrow H^+H^- \rightarrow t\overline{b}b\overline{t}$ (8 jet final state)





**1.2 TeV background** in the reconstruction window

**100 GeV background** after (tight) timing cuts



## Jet reconstruction at CLIC I





## Jet reconstruction at CLIC II



 $e^+e^- \to \tilde{q}_R \tilde{q}_R \to q \overline{q} \, \tilde{\chi}^0_1 \, \tilde{\chi}^0_1$ 

Two jets + missing energy



- Using Durham  $k_{T}$  à la LEP  $\rightarrow$  Timing cuts are effective, but not sufficient
- "hadron collider"  $k_{T}$ , R = 0.7
- → Background significantly reduced further
- $\rightarrow$  Need timing cut + jet finding for background reduction





# Physics benchmark studies

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Test of the di-jet mass reconstruction

Chargino and neutralino pair production:

$$e^{+}e^{-} \rightarrow \tilde{\chi}_{1}^{+}\tilde{\chi}_{1}^{-} \rightarrow \tilde{\chi}_{1}^{0}\tilde{\chi}_{1}^{0}W^{+}W^{-}$$

$$e^{+}e^{-} \rightarrow \tilde{\chi}_{2}^{0}\tilde{\chi}_{2}^{0} \rightarrow hh\tilde{\chi}_{1}^{0}\tilde{\chi}_{1}^{0} \qquad 82\%$$

$$e^{+}e^{-} \rightarrow \tilde{\chi}_{2}^{0}\tilde{\chi}_{2}^{0} \rightarrow Zh\tilde{\chi}_{1}^{0}\tilde{\chi}_{1}^{0} \qquad 17\%$$

Reconstruct  $W^{\pm}/Z/h$  in hadronic decays  $\rightarrow$  four jets and missing energy





Precision on the measured gaugino masses (few hundred GeV): 1 - 1.5%



### Test of the lepton reconstruction



- Slepton production very clean at CLIC
- SUSY "model II": slepton masses ≈ 1 TeV
- Investigated channels include:

$$\begin{split} e^+e^- &\rightarrow \tilde{\mu}^+_R \tilde{\mu}^-_R \rightarrow \mu^+ \mu^- \tilde{\chi}^0_1 \tilde{\chi}^0_1 \\ e^+e^- &\rightarrow \tilde{e}^+_R \tilde{e}^-_R \rightarrow e^+e^- \tilde{\chi}^0_1 \tilde{\chi}^0_1 \\ e^+e^- &\rightarrow \tilde{\nu}_e \tilde{\nu}_e \rightarrow e^+e^- W^+ W^- \tilde{\chi}^0_1 \tilde{\chi}^0_1 \end{split}$$





$m(\tilde{\mu}_{\rm R})$	•	$\pm 5.6  \text{GeV}$
$m(\tilde{e}_{R})$	•	$\pm 2.8  \text{GeV}$
$m(\tilde{v}_{e})$	•	$\pm 3.9  \text{GeV}$
$m(\tilde{\chi}_1^0)$	•	$\pm 3.0  \text{GeV}$
$m(\tilde{\chi}_1^{\pm})$	•	$\pm 3.7  \text{GeV}$

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Flavour tagging crucial!



#### Heavy Higgs bosons: $e^+e^- \rightarrow HA \rightarrow b\overline{b}b\overline{b}$ $e^+e^- \rightarrow H^+H^- \rightarrow t\overline{b}b\overline{t}$



Accuracy of the heavy Higgs mass measurements:  $\approx 0.3\%$ 

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• Full physics simulation and reconstruction with pileup from beam background ( $\gamma\gamma \rightarrow$  hadr.)

• Seven channels chosen to cover various crucial aspects of detector performance (jet measurements, missing energy, isolated leptons, flavour tagging, ...)





## **CLIC energy staging**

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## **CLIC energy staging**



#### Majority of CDR studies done at 3 TeV:

- Most challenging beam-induced backgrounds in the detectors
- Ultimate physics reach

#### Interesting physics (may) exist at various energies:

- Few 100 GeV:
- Precision SM measurements: Higgs, top,...
- Still unknown:
- Beyond Standard Model physics, potentially various thresholds from few 100 GeV to few TeV
- $\rightarrow$  Both require high luminosities!



- Significant luminosity penalty when running far below the nominal energy
- Possibility to start physics during construction phase for higher energies



## A possible scenario

#### Three energy stages:

- Exact energies to be determined by future results
- At 1.4 TeV only one drive beam complex needed
- → Natural intermediate stage









### Stage 1: $E_{CMS} = 500 \text{ GeV}, L = 500 \text{ fb}^{-1}$

- Top threshold scan (350 GeV)
- Higgs mass from ZH events (350 and 500 GeV)

### Stage 2: $E_{CMS} = 1400 \text{ GeV}, L = 1.5 \text{ ab}^{-1}$

- Higgs self-coupling
- Several SUSY studies using a specific model

## **Stage 3:** $E_{CMS} = 3$ **TeV**, L = 2 ab<sup>-1</sup>

Higgs self-coupling



## Higgs studies for Vol. 3



#### At 350 GeV and 500 GeV:

MM

W,Z

W,Z

- Higgs mass and cross section from ZH events
- Measurement of Z recoil allows measurement without assumption on Higgs decay modes



 $e^+, \overline{v_e}$ 

H⁰

e,ve

H<sup>0</sup>



Only possible at high energy (cross section)

e<sup>+</sup>



### SUSY model for staged energy studies



Quite different experimental challenges compared to the studies at 3 TeV, because SUSY particles produced close to threshold



$$M(\tilde{\tau_{1}^{+}}) = 517 \text{ GeV}$$

#### Requires identification of tau leptons!

 $e^+e^- \rightarrow \tilde{\tau}_1^+ \tilde{\tau}_1^- \rightarrow \tau^+ \tau^- \tilde{\chi}_1^0 \tilde{\chi}_1^0$ 



Mass precision: ≈11 GeV





## **Beyond the CDR**



## Next phase: 2012 - 2016



#### **Physics studies:**

- Follow up on 8 TeV and 14 TeV LHC results
- Full exploration of SM physics potential (Higgs, top)
- More detailed understanding of reach for new physics
- Refinement of strategy for CLIC energy staging

#### **Detector optimisation:**

 General detector optimisation & simulation studies in close relation with detector R&D

#### **Detector R&D:**

- $\bullet$  Implementation examples demonstrating the required functionality  $\rightarrow$  see next slide
- Strong overlap with ILC detector R&D programme



### **Detector R&D**



#### Vertex detector:

Demonstration module that meets the requirements

Main trackers: Demonstration modules, including manageable occupancies in the event reconstruction

Calorimeters: Demonstration modules, technological prototypes & cost mitigation

**Electronics:** Demonstrators, in particular in view of power pulsing

Magnet systems: Demonstrators of conductor technology, safety systems, etc.

#### Engineering and detector integration:

Engineering design and detector integration harmonised with hardware R&D demonstrators

#### → Considered feasible in a 5-year R&D program





# Summary and conclusions

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- Main message of the CLIC physics and detector CDR: Physics at a 3 TeV CLIC e<sup>+</sup>e<sup>-</sup> collider can be measured with high precision, despite challenging background conditions
- Backgrounds studied in detail:
  - Require high granularity in space and time
  - Define detector requirements and guide future R&D
- The performance of the CLIC detector concepts was demonstrated using detector benchmark reactions
- Next project phase (5 years):
  - CLIC detector R&D (within the international LC R&D program)
  - Further physics studies (LHC input) + detector optimisation





## **Backup slides**



## **Vertex detector layouts**









**CLIC\_SiD:** 5 single layers,  $2.76 \cdot 10^9$  pixels



## Examples for hybrid approach

#### Thinned high-resistivity fully depleted sensors:

- 50 µm active width
- Example: ALICE pixel upgrade → meets CLIC goals

#### Fast low-power readout chips:

- Timepix3 (2012) in 130 nm IBM CMOS:
  - 55 x 55  $\mu$ m<sup>2</sup> pixels
  - 1.5 ns time resolution  $\rightarrow$  exceeds CLIC goals
  - P  $\approx$  350 mW / cm<sup>2</sup>  $\rightarrow$  meets CLIC goals (with power pulsing)
- CLICPix (prototypes ≈2014) in 65 nm:
  - 20 x 20  $\mu$ m<sup>2</sup> pixels

#### Low-mass interconnects between senor+readout:

- Cost driver  $\rightarrow$  needs further R&D
- Technologies: Through-Silicon Vias (TSV),
- 3D interconnects, edgeless sensors, stitching of CMOS arrays









- Several active R&D programs (targeted to ILC requirements)
- Attempts to reach faster signal collection and ns time-stamping capability (compatible with CLIC requirements):
  - MIMOSA CMOS chip family (currently 350 nm):
  - developing high-resistivity epitaxial layers, smaller feature sizes
  - Chronopixel CMOS sensors with fully depleted epitaxial layer
  - **INMAPS** technology: deep p-well barrier protects n-well charge collector, improves charge collection, allows for high-resistivity epitaxial layer and full featured CMOS MAPS technology
  - High voltage CMOS: CMOS signal processing electronics embedded in reverse-biased deep n-well that acts as signal collecting electrode
  - Silicon-On-Insulator (SOI): ≈200 nm SiO<sub>2</sub> isolation layer separates

charge collection and readout functionality

- Full 3D-integrated pixel sensors: Thinned high-resistivity sensitive tier coupled to additional tiers with advanced analog+digital functionality



### **HCAL resolution**







## **PFO based timing cuts**



Region	p <sub>t</sub> range	Time cut		
Photons				
central	$0.75~{ m GeV} \le p_t < 4.0~{ m GeV}$	t < 2.0 nsec		
$(\cos  heta \leq 0.975)$	$0~{ m GeV} \le p_t < 0.75~{ m GeV}$	t < 1.0 nsec		
forward	$0.75~{ m GeV} \le p_t < 4.0~{ m GeV}$	t < 2.0 nsec		
$(\cos \theta > 0.975)$	$0~{ m GeV} \le p_t < 0.75~{ m GeV}$	t < 1.0 nsec		
Neutral hadrons				
central	$0.75~{ m GeV} \le p_t < 8.0~{ m GeV}$	t < 2.5 nsec		
$(\cos  heta \leq 0.975)$	$0~{ m GeV} \le p_t < 0.75~{ m GeV}$	t < 1.5 nsec		
forward	$0.75~{ m GeV} \le p_t < 8.0~{ m GeV}$	t < 2.0 nsec		
$(\cos \theta > 0.975)$	$0~{ m GeV} \le p_t < 0.75~{ m GeV}$	t < 1.0 nsec		
Charged PFOs				
all	$0.75~{ m GeV} \le p_t < 4.0~{ m GeV}$	t < 3.0 nsec		
	$0~{ m GeV} \le p_t < 0.75~{ m GeV}$	t < 1.5 nsec		

- Track-only minimum p<sub>t</sub>: 0.5 GeV
- Track-only maximum time at ECAL: 10 nsec













Figure 19: Separation of *W* and *Z* from the chargino decay without overlay (left) and with 60 BX of background (right) for CLIC\_SiD.